

SURFBOARDS®

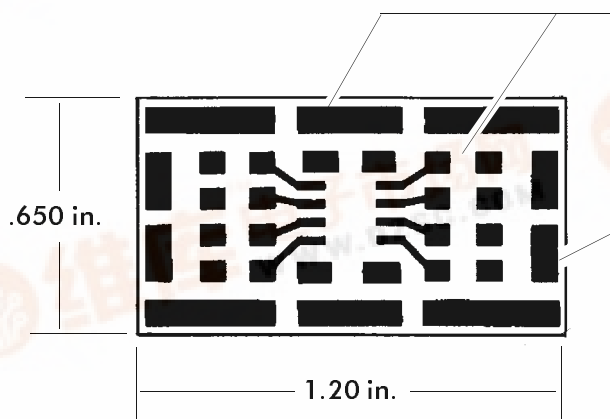


THE BREADBOARDING MEDIUM FOR SURFACE MOUNT™

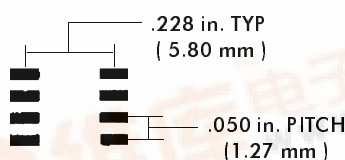
9000 SERIES FOR I.C.s

IDS9081A 3-9-99

MODEL **9081** ACCEPTS 8-PIN S.O.I.C.
FOR GENERAL PURPOSE PROTOTYPE AND DEVELOPMENT



Pad sets accept 1206, Mini-Melf devices. Peripheral pads provide additional breadboarding area.

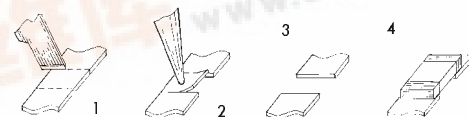


I.C. Footprint accepts industry standard S.O.I.C. packages

FOIL MODIFICATIONS EXPAND VERSATILITY

Typical of many Surfboards are large pad areas which may be modified to create additional part mounting zones or expand layout or connection options.

- 1: Score foil with sharp razor to define new zone.
- 2: Apply heat with iron to delaminate foil section.
- 3: New mounting zone has been created.
- 4: Solder component to new mounting zone.



OTHER SURFBOARD MODELS
FOR USE WITH 8 - 14 - 16 PIN SOICs
SEE

9082, 9161, 9162
9163, 9164 and 9165

BOARD SPECIFICATIONS

BOARD MATERIAL: .031+-.005 in. Thick G-10 FR-4 Glass Epoxy or equivalent.
CIRCUITS: 1oz Copper with solder coated pads.
TOLERANCES: Given in inches
Board Size +-.020 / OAL+-.040
Circuit pattern/position +-.005

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